

Product Change Notice

PCN Number: 13-0730-01 Issue Date: 09-SEPTEMBER-2013

Exar Corporation

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PRODUCTS AFFECTED:	SP3070EEN-L	SP3070EEN-L/TR	
	SP3071EEN-L	SP3071EEN-L/TR	
	SP3072EEN-L	SP3072EEN-L/TR	
	SP3073EEN-L	SP3073EEN-L/TR	
	SP3074EEN-L	SP3074EEN-L/TR	
	SP3075EEN-L	SP3075EEN-L/TR	
	SP3076EEN-L	SP3076EEN-L/TR	
	SP3077EEN-L	SP3077EEN-L/TR	
	SP3078EEN-L	SP3078EEN-L/TR	
CHANGE CATEGORY:			
		N	
Material			Package
Design		Datasheet	Packing/Shipping
Other: Alternate Foundry and Assembly/Test Site			
DESCRIPTION OF CHANGE:			
Qualification of 0.25um CMOS process at TSMC.			
Qualification of alternate assembly sites, Carsem (for 8 and 14L nSOIC) and ASE Chung-Li (for 8L nSOIC).			
IMPACT OF CHANGE:			
There is no change to product form, fit or function.			

TARGET IMPLEMENTATION DATE: 09-DECEMBER-2013

Please contact customer support (customersupport@exar.com) for sample date availability or qualification data

PROPRIETARY INFORMATION

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